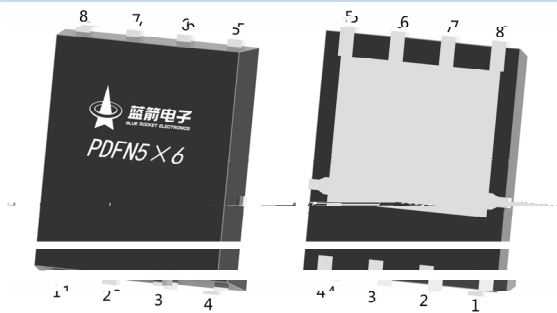
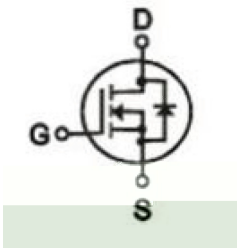


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Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	S
8	S



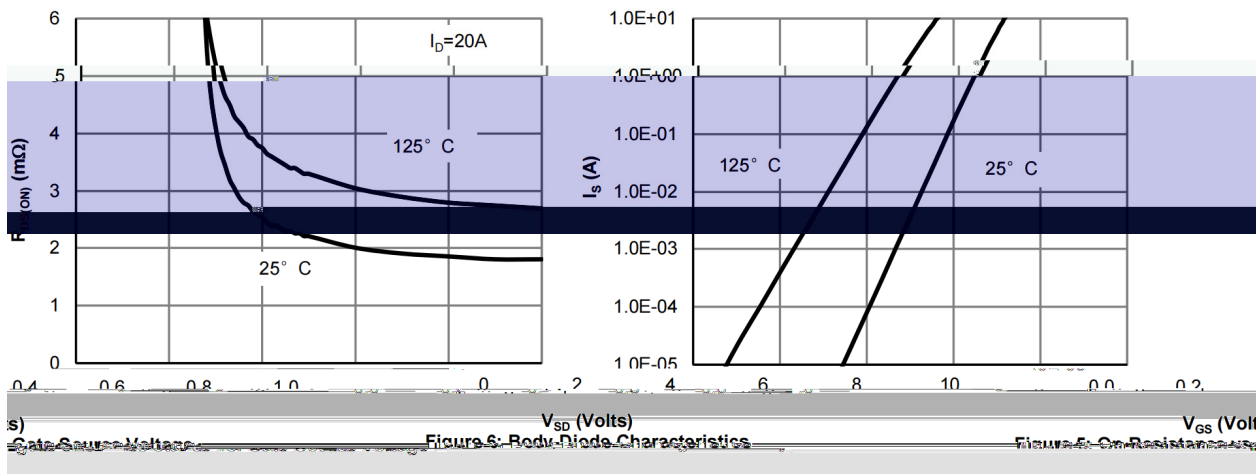
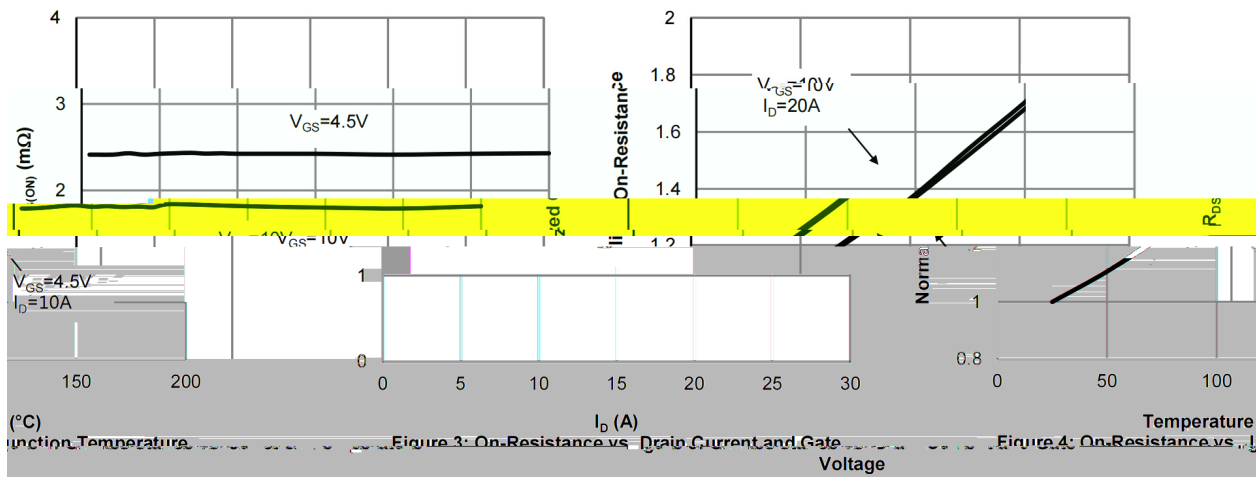
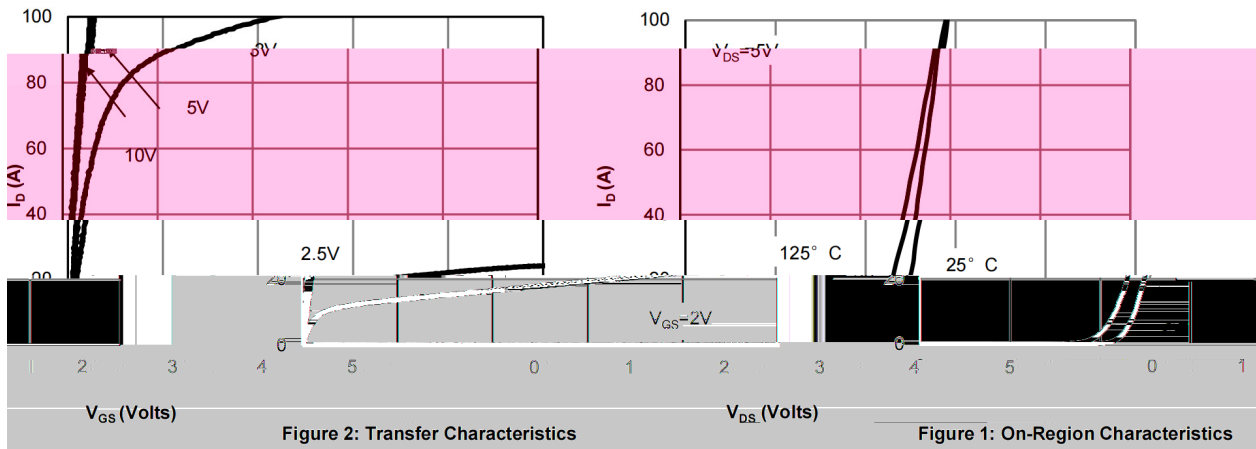
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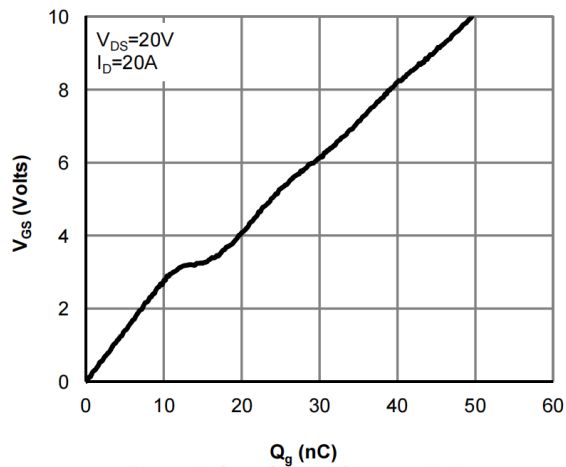


Figure 7: Gate-Charge Characteristics

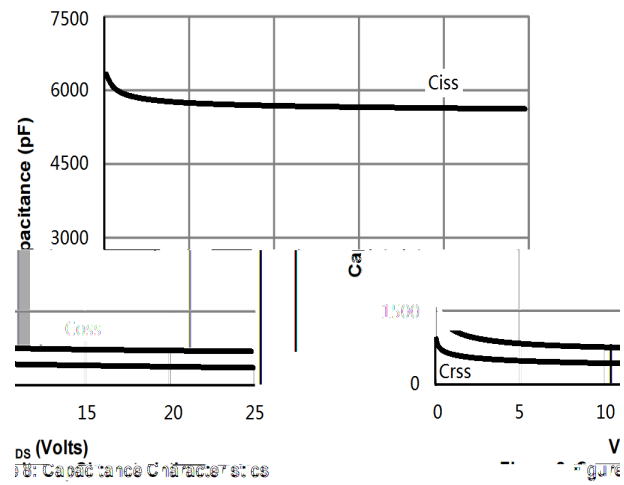


Figure 8: Capacitance Characteristics

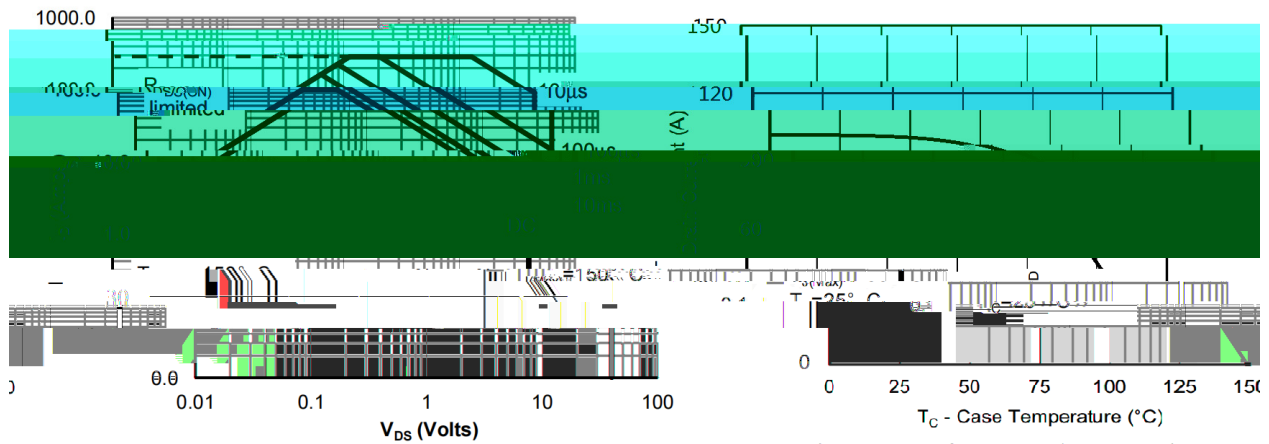


Figure 9: Maximum Forward Biased Safe Operating Area

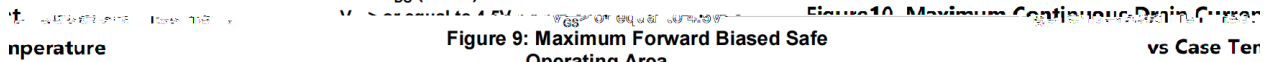
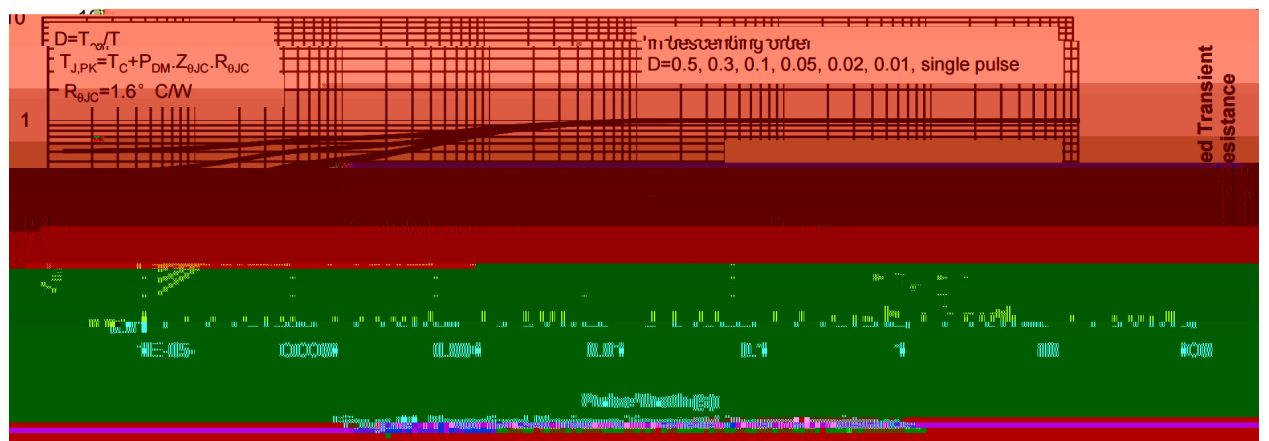


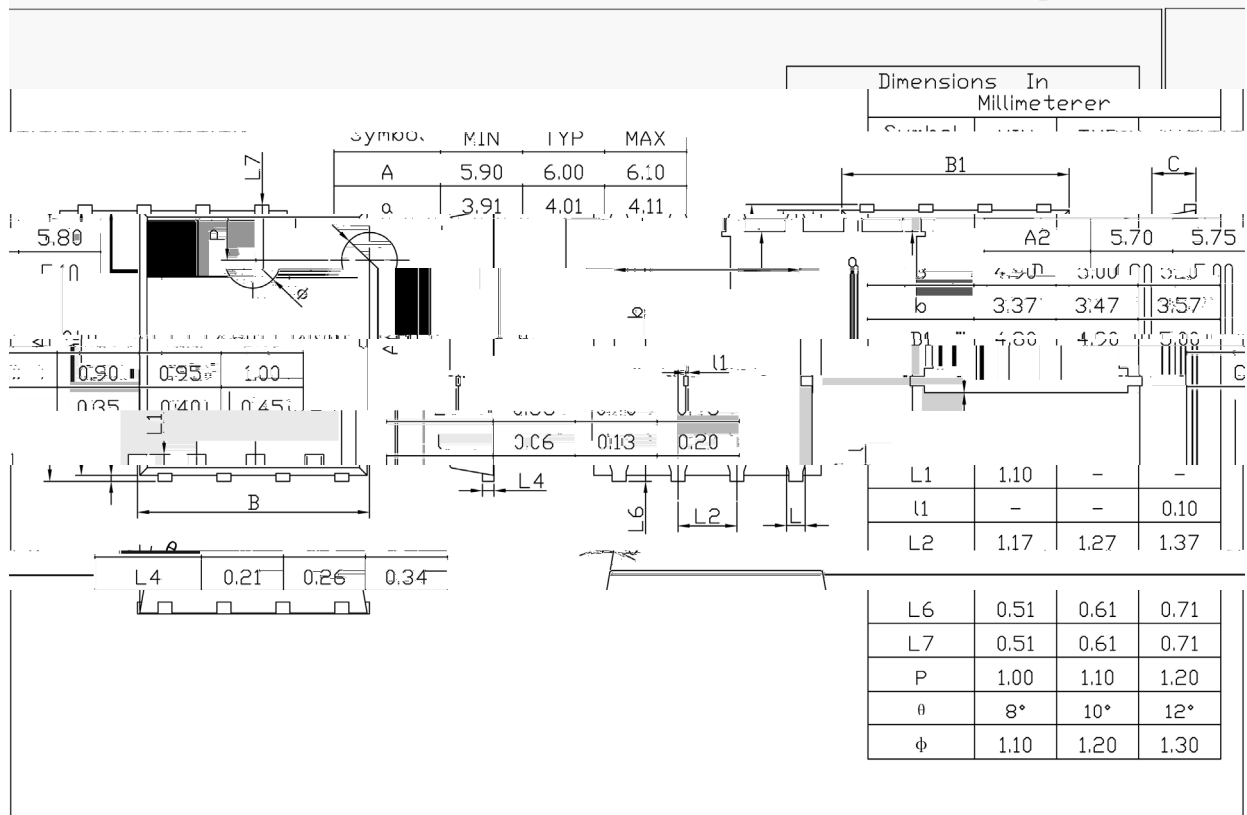
Figure 10: Maximum Continuous Drain Current vs Case Temperature



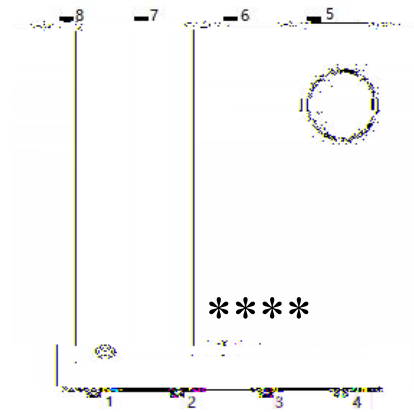
PDEN15 X6

0.1mm STEP 1:2.5X

Unit:mm



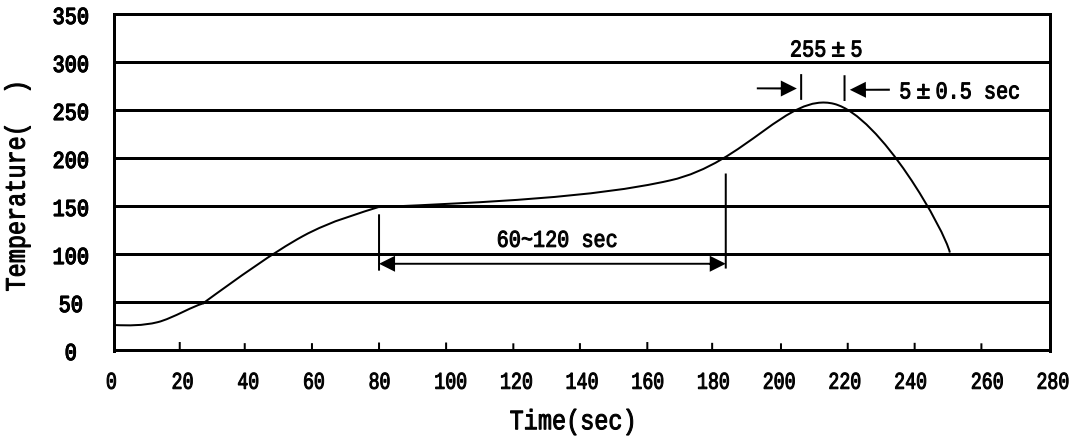
Rev.00 201812



BR

Q

Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ± ± ±

	包装数量					包装尺寸		
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
×						×	×	×

×